



SAH
#SA
8-11-00


IN THE
UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANTS: Steven F. Reiber et al.
SERIAL NO.: 09/514,454
FILING DATE: February 25, 2000
TITLE: Dissipative Ceramic Bonding Tip
ATTY.DKT.NO.: PA1118US

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: BOX MISSING PARTS, Commissioner of Patents and Trademarks, Washington, D.C. 20231, on the date printed below:

Date: May 30, 2000


David Lewis

PRELIMINARY AMENDMENT

Sir;

Please amend the specification as follows:

In the specification:

On page 1, line 10, insert - -

CROSS REFERENCE TO RELATED APPLICATIONS

This application claims benefits of Provisional Application S.N. 60/121,694, filed

February 25, 1999, entitled Dissipative Ceramic Bonding Tip. - -

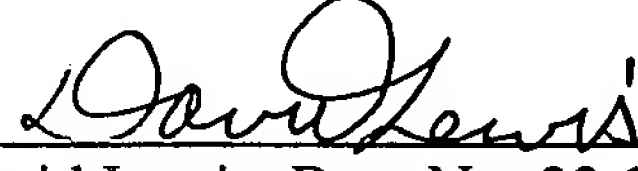
Line 11, delete "1."

Line 17 delete "2."

Date: May 30, 2000

By:

Respectfully submitted,
Steven F. Reiber et al.


David Lewis, Reg. No. 33,101
Carr & Ferrell, LLP
2225 East Bayshore Road, Suite 200
Palo Alto, CA 94303
TEL: (650) 812-3400
FAX: (650) 812-3444